



Pulp and Paper Industry Committee James A. Rooks Memorial Student Intern Program Application

One of the challenges the Pulp and Paper Industry faces going forward is attracting and retaining new, young electrical engineering professionals to the industry. Recognizing this need, the IEEE Pulp and Paper Industry Committee (PPIC) has arranged with the IEEE Industrial Applications Society (IAS) to sponsor up to four Co-op/Intern Students to their upcoming Annual Conference.

What is included?

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| ✓ Travel and Lodging Expenses up to \$2,000 | ✓ Conference Reception |
| ✓ Conference Registration | ✓ Conference Social Event |
| ✓ One Tutorial | ✓ Meals |
| ✓ Vendor Exhibition | ✓ IEEE and IAS Membership |

What are the requirements?

- The student must be a member (or willing to join) of IEEE and IAS.
- The student's mentor from the Mill (or another co-worker) must attend with them.
- IEEE/IAS will reimburse either the student or company for the documented travel costs of airfare, other transportation, and meals up to a maximum of \$2,000 per student.
- Reimbursement will take place after the completion of the conference.
- The student must attend one sub-committee meeting and the general committee meeting.
- Preference will be given to students working for a Mill.
- The student's employer must be willing to pay them their normal salary while they are at the Conference (we don't want them to have to take time off to attend).
- Open to North American students only.

A few highlights from the Conference:

- Welcome Reception at the hotel on Sunday evening.
- Technical paper presentations, vendor exhibitions, and panel discussions over the course of 3 days.
- Conference Closing event, including dinner and the Technical Paper Awards.
- PPIC Subcommittee meetings are held, which is where the ideas for future papers are presented.

The PPIC Subcommittees are:

DCS – Drives and Control Systems

PCEMC – Process Control, Engineering, Maintenance and Construction

PDS – Power Distribution Systems

S&T – Safety and Training

Standards – Development of IEEE Standards as related to the Pulp and Paper Industry

Visit www.pulppaper.org for more information on the Conference!



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NAME	
PREFERRED FIRST NAME <i>(if different)</i> & PRONOUNS	
IEEE MEMBER NUMBER <i>(if already a member)</i>	
ACTIVE EMAIL ADDRESS	
PHONE NUMBER	
COMPANY	
COMPANY LOCATION <i>(Mailing Address)</i>	
COLLEGE NAME & LOCATION	
DEGREE & LEVEL COMPLETE <i>(as of June before the Conference)</i>	
ANTICIPATED GRADUATION DATE	
NAME & TITLE OF MENTOR ATTENDING CONFERENCE	
SUBCOMMITTEE PREFERENCE	
TUTORIAL PREFERENCE	
DIETARY RESTRICTIONS	

If you are not currently a member of IEEE and the IAS, you will be required to join IEEE and the IAS as a student member before attending the conference. First year membership fees will be reimbursed after the conference.

Please return this application by **MAY 10** via e-mail, and direct any questions to:

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217-827-4099